MRO Delay Line ICD

Delay Line to Beam Combining Facility ICD INT-406-VEN-0009

The Cambridge Delay Line Team

rev 0.7

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Cavendish Laboratory JJ Thomson Avenue Cambridge CB3 0HE UK

1 ICD Description

ICD	Sub-systems		Org	Owner	Brief description and preliminary	
Number					contents	
INT-406- VEN-0009	Delay line	BCF infrastructure (building)	MRAO	MF	 Defines the mechanical and space envelope interfaces between the delay lines and the BCF (DLA and BCA areas). Layout of delay line pipes and interface of supports to floor 	
					 Interface of supports to field Interface between delay line pipes and walls Services requirements and placement of control racks 	

Specific entry from the ICD N^2 Table contained in FDR document:

2 Change Record

Revision	Date	Authors	Changes
0.1	2007-08-10	MF	First draft version
0.2	2009-04-07	MF	Updated with most interface details
0.3	2009-04-28	MF	Revised Low latency cable and connectors
			Table 2 page 11
			Revised end plate drawing – page 12
			Revised datum switch connector and removed
			interface box – pages 7 and 12
			Added anchor bolt lengths on pages 10 and 11
			Included drawing MROI087-02 in appendix
0.4	2009-05-20	MF	Revised MROI assembly drawing for DL pipe
			replaces drawing MROI087-02
0.5	2009-06-16	MF	Revised low latency cable to plenum type: p11
0.6	2010-09-17	MF	Revised inductive power cable & connector: p11
			Revised appearance and cable entry of inductive
			power inverter.
0.7	2010-10-15	MF	Assigned pin numbers to power connectors p11

3 Notification List

The following people should be notified by email that a new version of this document has been issued:

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4 Scope

This ICD relates the delay line to the BCF. This includes the mechanical interfaces between the pipe supports, including the anchors, and the DLA slab; the pipes and the walls through which they pass in the BCF; the electronics to be situated in the DLA and connections to the delay line pipe but not the connections between the delay line pipe and the VME system (which is covered in the Metrology to BCF interface) nor the delay line pipe and the vacuum system which is covered in a separate ICD.

5 Acronyms and Abbreviations

- **BCA** Beam Combining Area
- **BCF** Beam Combining Facility
- **BRS** Beam Relay System
- **DL** Delay Line
- **DLA** Delay Line Area
- **ICD** Interface Control Document
- ICS Interferometer Control System

MROI Magdalena Ridge Observatory Interferometer
MRAO Mullard Radio Astronomy Observatory
NMT New Mexico Tech
OPD Optical Path Delay

6 Applicable Documents.

- AD1 Delay Line Pipes & Supports Design Description v1.0 (INT-406-VEN-0115)
- AD2 Anchor bolt specification and installation documents

DRAWINGS

- AD3 Drawing of interface detail for support leg to slab (template of hole centres).
- AD4 Drawing of interface detail for anchor to slab (template of hole centres).
- AD5 Drawing of support and anchor locations on floor slab. MROI Infrastructure BCF
- AD6 Cabling Schematics.

REFERENCE DOCUMENTS

- RD1 Delay line to Beam Relay system (INT-406-VEN-0008)
- RD2 Delay line to metrology system (INT-406-VEN-0010)
- RD3 Metrology System to BCF (INT-406-VEN-0012)
- RD4 Metrology System to Beam Relay System (INT-406-VEN-0013)
- RD5 Anchor Requirements for Delay Line Supports
- RD6 Drawings: Delay line supports and anchor.
- RD7 Proposed Delay Line Tools, Jigs and Handling Procedures (INT-406-VEN-0119)

7 Introduction

The delay lines are mounted on support frames which are fixed to the delay line slab in the DLA using chemical anchor bolts. The supports are fitted at locations where the pipes are joined and a special support, called an anchor is, is located near to the BCA end of the DLA on a specially thickened part of the floor slab. The anchor restrains the delay line in the longitudinal directions and therefore must be capable of taking substantial load in that direction.

In order for the delay line pipe sections to be correctly installed and aligned the holes for the bolt locations for the supports and the anchor must be accurately surveyed, marked and then drilled into the concrete slab. This document provides the necessary details for the location of holes for the delay line supports and the anchors. Drawings are provided from which drilling templates may be manufactured. The location of support points depend on the length of pipe sections to be fitted but the majority of pipes are standard lengths of 12 feet. Also, the exact centreline for each delay line

must be determined before the holes for the supports can be referenced to it. Positions for the hole locations starting from the metrology end of the delay line are given in the assembly drawing included in the appendices.

The delay line pipes pass through the DLA/BCA wall and inner BCA wall in slots which have been incorporated when the structure was built. The interface with these slots is to be light-tight, have good thermal properties yet minimise the transmission of vibrations.

The delay lines also require signals and services that are to be provided by electronics placed in racks or enclosures situated at locations in the DLA. The details of those connections are provided here, together with the requirements and interfaces for the racks.

8 Requirements

8.1 Mechanical Interfaces

8.1.1 Delay Line supports to DLA slab

Each delay line support is required to be connected to the DLA floor slab by four anchor bolts which project from the concrete through oversized holes in the support base. These anchor bolts are to be of sufficient length to allow the height of each support to be adjusted so that the delay line pipe is optimally adjusted with reference to the nominal incoming beam axis. Adjustment of the lateral position of the pipe can be undertaken at the support base, using the oversize holes or by applying a small tilt to the base.

8.1.2 Delay Line anchor to DLA slab

The delay line anchor requires larger diameter anchor fixings and many more than with a support; it is also to be grouted to the floor to provide a stronger connection. The anchor bolts must be long enough to allow for sufficient grout thickness between the anchor and the floor, taking into account any unevenness in the floor slab or fabrication error in the anchor frame.

8.1.3 Delay Line Pipe to DLA wall

The delay line pipes must pass through the wall of the DLA into the outer BCA area without undue coupling of vibration. A slot has been incorporated into the design of the building to allow for this. At some stage the gap between the delay line pipes and the wall must be filled to provide a thermal barrier and also be light tight. The material or structure used to fill the gap must be capable of being removed for the purposes of future re-alignment of the delay line should it become necessary.

8.1.4 Delay Line pipe to inner BCA wall

The delay line pipes must pass through the wall of the BCA into the inner BCA area without undue coupling of vibration. A similar arrangement to that provided in 8.1.3 is to be made.

8.2 Electronic Interfaces

8.2.1 Delay Line Modules to DLA

At the 'far' end of each delay line there are two modules, the RF module and the inductive power (IP) module, mounted on the end plate. The RF module accepts two cables directly from the DLA and 5V power from a local source. One of the cables is a standard network connection and the other is a screened twisted pair carrying the low-latency signal from the VME System located in the outer BCA. The IP module requires 48V power from a local source. A small enclosure (referred to as a local DL enclosure) should be mounted at the foot of each delay line to house power supplies which provide 5V and 48V to the modules mounted on

the end-plate of the delay line. Utility power should be fed to each local DL enclosure.

8.2.2 Delay Line Datum facility

The datum facility is an optical switch mounted close to the anchor position on each delay line. The switch must be electrically isolated from the DL pipe but the cable screened and grounded at the VME System. Each datum switch shall be separately connected to the appropriate channel of the custom circuit board in the VME system which is located in the outer BCA.

8.3 Services

The following services are required for each delay line and are listed together with other cabling requirements.

- Utility power: to be supplied to each local DL enclosure.
- Network: to be supplied to each DL RF module

Because delay lines will initially be of different lengths it may be necessary to provide power cabling from different points along the length of the DLA.

Network connections could all come from the far end of the DLA if it is preferred that all switches are located in one position.

8.4 Cabling

The cabling required to be routed to each delay line is listed in Table 1 below. In this table 'n' refers to the delay line number. The suggested cabling arrangement for handling different lengths of delay line is shown in Figure 2.

Cable	From	То
Low latency analogue signal n	VME System (BCF)	DL n RF module
Datum signal and power n	VME System (BCF)	DL n datum switch
Network n	Network outlet	DL n RF module
Power supply for RF module	Local DL enclosure n	DL n RF module
Power supply for inductive power (IP) module	Local DL enclosure n	DL n IP module
Utility power	Utility power circuit	DL n local enclosure

Table 1 Delay line cabling required in the DLA (n is the delay line number)

9 Design

At the 'far' end of each delay line there are three electrical connections to the pipe, each with low voltage power supply requirements. For each delay line, two RF signals and one inductive power signal are injected into the pipe from modules mounted on the pipe end plate. The RF module houses both the network RF transceiver (wi-fi access point) and the low latency RF transmitter link. The inductive power module houses the inductive power inverter circuitry. A diagram of the connections at the end of each delay line is shown in Figure 1.

9.1.1 The RF Module.

This module houses a commercially available 'wireless access point' unit to provide network communication to the trolley and a custom designed circuit to launch the low latency signal over a modulated RF transmission.

The network input is obtained from a network switch located in the DLA (probably at the far end). The network cable passes through a hole in the RF module to plug directly into wireless access point unit inside. The output signal from the wireless access point unit is fed through a hole in the RF module and plugs into a feed-through connector on the pipe end plate which is connected to an aerial mounted internally. The module requires 5V power (shared it with the low latency link module) which is provided by the power supply unit in the local DL enclosure

The low latency cable from the VME system located in the outer BCA plugs directly into the RF module via a LEMO type connector. Internally this connects to the low-latency circuit housed in a box within the RF Module. The circuit accepts the differential analogue signal over a twisted pair cable from the VME system and converts it to modulated RF. The RF signal passes through a hole in the RF Module and plugs into a connector on the pipe end plate which connects to another aerial mounted internally.

9.1.2 The Inductive Power Module.

This module houses an inverter which operates at about 22kHz and supplies approximately 2A at nominally 40V to the primary circuit i.e. the wire running down the inside of the pipe with the return path being the pipe itself. The output of the module connects to a feed-through connector mounted in the end plate. The IP module requires a 48V 5A power supply which should be mounted in an enclosure reasonably close by. An enclosure situated the foot of the far end of each delay line is the best arrangement.

9.1.3 Local DL enclosure

This enclosure will have utility power fed to it to provide for the power supplies and also local outlets for extra lighting, soldering iron or test equipment. A suitable 48V power supply unit for the inductive power supply is the Altech PSP-24048 which is DIN rail mounting and a suitable 5V power supply is the IDEC PS5R-SB05 which is also DIN rail mounting. Both supplies are fan-less. Data sheets for these supplies are included in the appendix.

9.1.4 The Datum Switch

The datum switch is mounted in an assembly inserted into the delay line pipe close to the anchor position. It is electrically isolated from the pipe and comes with a connector pre-wired with a 2m lead with tails. This lead is to be discarded and a connector supplied which allows a long cable to be connected directly from the custom board in the DL VME System located in the outer BCA to the datum switch.



Figure 1 Modules located at the far end of each delay line.



Figure 2 A possible arrangement of cabling for delay lines of different length from 30m to 190m. The analogue low latency cables are full length but pulled back to the appropriate delay line. The network cable between the delay line and the switch should not be longer than 100m and so should be located in a rack in an intermediate position along the DLA and connected to a separate shorter 1GB fibre. The 48V and 5VDC power supplies should be in enclosures at the end of each delay line. The datum signal cables are connected to boxes mounted on the anchor of each delay line. (Note that not all the cables are shown for clarity of the drawing but it is expected that cables will route down one side of the DLA and into the outer BCA close to the DL Electronics rack which houses the VME system.)

10 Defined Interfaces

10.1 Mechanical Interfaces

10.1.1 Delay Line supports to DLA slab

Each delay line support is required to be connected to the DLA floor slab by four anchor bolts which project from the concrete through oversized holes in the support base. These anchor bolts are to be of sufficient length to allow the height of each support to be adjusted so that the delay line pipe is optimally adjusted with reference to the nominal incoming beam axis. The offset of the support base from the floor of the DLA must not exceed 45mm and so, to accommodate variation in the level of the DLA slab, two support base types are defined with the only difference being the height of the attachments for the legs of the support (see Figure 3. The appropriate support base should be used so that the offset referred to above is not exceeded. Adjustment of the lateral position of the pipe can be undertaken at the support base, using the oversize holes or by applying a small tilt to the base.



Figure 3 The use of two types of support plate with different heights to accommodate the variation in level of the DLA floor.

The interface with the DLA floor is the hole-pattern of the support base. The dimensions for the hole-pattern are given by drawing MROI-072. A pdf copy of this drawing is included in the appendix.

The appropriate anchor bolt for the DL supports is: HILTI type 5/8" ASTM A 193 B7 6 ³/₄" or equivalent, using an embedment depth of 4" (101.6mm), see drawing MROI 087-02 also given in the appendix.

10.1.2 Delay Line anchor to DLA slab

The delay line anchor requires larger diameter anchor fixings and many more than with a support; it is also to be grouted to the floor to provide a stronger connection. The anchor bolts must be long enough to allow for sufficient grout thickness between the anchor and the floor, taking into account any unevenness in the floor slab or fabrication error in the anchor frame.

The interface with the DLA floor is the hole-pattern of the anchor base. The dimensions for the hole-pattern are given by drawing MROI-078-02. A pdf copy of this drawing is included in the appendix.

The appropriate anchor bolt for the DL anchor is: HILTI type $\frac{3}{4}$ " ASTM A193 B7 9 $\frac{1}{2}$ " or equivalent, using an embedment depth of $\frac{6-3}{4}$ " (171.5mm) drawing MROI 087-02 also given in the appendix. The torque on the studs for clamping the nuts should not be larger than 54Nm.

10.1.3 Delay Line Pipe to DLA wall

The delay line pipes must pass through the wall of the DLA into the outer BCA area without undue coupling of vibration, must provide a thermal barrier and also be light tight. The material or structure used to fill the gap must be capable of being removed for the purposes of future re-alignment of the delay line should it become necessary.

10.1.4 Delay Line pipe to inner BCA wall

The delay line pipes must pass through the wall of the BCA into the inner BCA area without undue coupling of vibration. A similar arrangement to that provided in 8.1.3 is to be made.

10.2 Electronic Interfaces

10.2.1 Delay Line Modules to DLA

The RF module accepts two cables directly from the DLA and 5V power from a local source. One of the cables is a standard network connection and the other is a screened twisted pair carrying the low-latency signal from the VME System located in the outer BCA. The IP module requires 48V power from the local DL enclosure. The position and orientation of these modules on the end plate is shown in Figure 4. The interface connections and cable types are given in Table 2. Connection details for the low-latency link cable are given in RD2.

Cable	From	То	Cable type
	[Cable connector]	[Cable connector]	
Low latency	VME System (BCF)	DL RF module *	2-conductor stranded, foil
analogue	[3-way Lemo 0B plug	[3-way Lemo 0B plug	shielded with drain wire
signal	FGG.0B.303.CLAD42Z]	FGG.0B.303.CLAD42Z]	Belden 9451P
Network	Network outlet	DL RF module	Standard CAT5 connection
Power supply	Local DL enclosure	DL RF module	2-conductor cable with shield,
for RF	Suggest use of same	[2-way Lemo 1B plug	diameter 3.1mm to 4mm
module	connector type as at RF	FGG.1B.302.CYCD42Z]	Alpha Wire 58431
	module.		Pin 1 +5V Pin2 0V
Power supply	Local DL enclosure	DL IP module	~3.5m 3-conductor stranded
for IP module	Wire terminals	Bulgin PX 0731/P	10A rated 1mm ² cross section
		Pin L +48V Pin N 0V	or equivalent (AWG 18)
		Pin G Gnd	

Table 2 Interface connections, pin numbers and cable types the RF module and IP module

* Note: shield of cable is not to be connected at the DL end of the cable.



Figure 4 Arrangement of modules on the end plate of the delay line showing interface connections. The Inductive Power Module is representative only as the box for this is yet to be chosen so that it can accommodate a local reset switch. The two aerial connections leave the Communications Module through holes as does the network cable as these have connectors internally. The two connectors for the communications module are specified in Table 2.

10.2.2 Delay Line Datum facility

The datum facility is an optical switch mounted close to the anchor position on each delay line. The switch must be electrically isolated from the DL pipe but the cable screened and grounded at the VME System. Each datum switch shall be separately connected to the appropriate channel of the custom circuit board in the VME system which is located in the outer BCA. Connection details are given in RD2.

Cable	From	То	Cable type	
	[Cable connector]	[Cable connector]		
Datum	VME System (BCF)	DL datum switch	4-conductor stranded,	
signal and	[5-way Lemo 0B plug	[Harting Harax M12	shielded	
power	FGG.0B.305.CLAD42Z]	female plug	diameter 3.1mm to 3.4mm	
		part 21 03 221 2405]	Alpha Wire 57004	

11 Appendices

- Page 1 MROI Infrastructure: location and assembly of DL pipes close to the BCA
- Page 2 Assembly drawing of pipe support for fixing hole pattern
- Page 3 Anchor support assembly for fixing hole pattern
- Page 4 Altech PSP240 48V DC power supply specification sheet
- Page 6 IDEC PS5R-S 5V DC power supply specification sheet







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- 3 years warranty



SPECIFICATION

MODEL		PSP-24024	PSP-24048			
		24\/	48//			
	RATED CURRENT	104	54			
		0~10A	0~54			
	RATED POWER	240W	240W			
	RIPPLE & NOISE (max.) Note 2	80m\/r-n	150m/n-n			
OUTPUT	VOLTAGE ADL RANGE	24 ~ 28V	48 ~ 5V			
	VOLTAGE TOLERANCE Note 3	+1.0%	+1.0%			
		+0.5%	+0.5%			
	LOAD REGULATION	+1.0%	+1.0%			
	SETUP, RISE, HOLD TIME	800ms, 40ms, 20ms/230VAC 8 00ms, 40ms, 20ms/115VAC a	at full load			
	VOLTAGE R ANGE	85 ~ 264VAC 1 20 ~ 370VDC				
	FREQUENCY RANGE	47 ~ 68Hz				
	POWER FACTOR	PE>0.95/230VAC PE>0.98/115VAC at full load				
INPUT	EFFICIENCY (Typ.)	84%	85%			
	ACCURRENT	3.5A/115VAC 1.8A/230VAC				
	INRUSH CURRENT (max.)	COLD START 30A/115VAC 5 0A/230VAC				
	LEAKAGECURRENT	<3.5mA / 240VAC				
		105 ~ 150% rated output power				
	OVERLOAD	Protection type : Constant current limiting, recovers automatically after fault condition is removed				
DROTECTION		30 ~ 36V	54 ~ 60V			
PROTECTION	OVER VOLTAGE	Protection type : Shut down o/p voltage, re-power on to recover				
		$100^\circ\!\mathrm{C}\pm\!\!5^\circ\!\mathrm{C}$ (TSW1)Detect on heat sink of power transistor				
	OVERTEIMPERATORE	Protection type : S hut down o/p voltage, recovers automatically after temperature goes down				
	WORKING TEMP.	$10 \sim +70^\circ C$ (Refer to output load derating curve)				
	WORKING HUMIDITY	20 ~ 90% RH non-condensing				
ENVIRONMENT	STORAGE TEMP., HUMIDITY	-20 ~ +85°C , 10 ~ 95% RH				
	TEMP. COEFFICIENT	±0.03%/°C (0 ~ 50°C)				
	VIBRATION	10 ~ 500Hz, 2G 10min./1cycle, 60min. each along X, Y, Z axes				
	SAFETY STANDARDS	UL508, UL60950-1, EN60950 Approved				
	WITHSTAND VOLTAGE	I/P-O/P:3KVAC I/P-FG:1.5KVAC O/P-FG:0.5KVAC				
SAFETY &	ISOLATION RESISTANCE	I/P-O/P, I/P-FG, O/P-FG:100M Ohms/500VDC				
EMC	EMI CONDUCTION & RADIATION	Compliance to EN55011, EN55022 (CISPR22) Class B				
(Note 4)	HARMONIC CURRENT	Compliance to EN61000-3-2,-3				
	EMS IMMUNITY	Compliance to EN61000-4-2,3,4,5,6)移用NV50204, EN55024, E	N61000-6-2 (EN50082-2) Heavy industry level, <i>d</i> iiteria			
	MTBF	105.5Khrs min. MIL-HDBK-217F (25℃)				
OTHERS	DIMENSION	125.5*125.2*100mm (W*H*D)				
	PACKING	1.2Kg; 20pcs/14.4Kg/1.2CUFT				
NOTE	 I. A II parameters N OT s pecially mentioned are measured at 230VAC input, rated load and 25°C of a mbient temperature. 2. R ipple & n oise are measured at 20MHz of bandwidth by using a 1 2" twisted pair-wire terminated with a 0.1 uf & 47uf parallel capacitor. 3. T olerance : i ncludes s et up tolerance, line regulation and load regulation. 4. T he power s upply is c onsidered a c omponent which will be installed into a final equipment. T he final equipment must be re-confirmed that it still m EMC d irectives. 					



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 - Meets SEMI F47 Sag Immunity (120W & 240W)
 - NEC Class 2 rated (15W, 30W & 60W)
 - Approved for Class 1, Div. 2 Hazardous Locations
 - Fused input
 - Overcurrent protection, auto-reset
 - Overvoltage protection, shut down
 - Spring-up Screw Terminal type, IP20
 - DIN rail or Panel Surface Mount
 - Approvals:
 - CE Marked, TÜV, c-UL, UL 508, UL 1310 (PS5R-SB, -SC, -SD), UL 1604, EN 50178:1997, LVD: EN60950:2000, EMC: Directive, EN61204-3:2000 (EMI: Class B, EMS: Industrial)

Specifications







For more information on these and other IDEC power supplies, visit:

www.idec.com/powersupply

opeemeatione		IVEVV						
		5V DC output	PS5R-SB05	-	-	-	-	-
Part Numb	ers	12V DC output	PS5R-SB12	PS5R-SC12	-	-	-	-
		24V DC output	PS5R-SB24	PS5R-SC24	PS5R-SD24	PS5R-SE24	PS5R-SF24	PS5R-SG24
Output Capacity		15W (5V Model is 10W)	30W	60W	90W	120W	240W	
	Input Voltage (single-phase, 2-wire)		85 to 264 VAC, 100 to 370 VDC			85 to 264V AC, 100 to 350V DC		
	Input Current	100VAC	0.45A	0.9A	1.7A	2.3A	1.8A	3.5A
	(maximum)	200VAC	0.3A	0.6A	1.0A	1.4A	1.0A	1.7A
	Internal Fuse Ratin	ıg	2A	3.15A	3.15A	4A	4A	6.3A
Indu	Inrush Current (col	d start)			50A max	imum (at 200V AC)		
	Leakage Current (a	it no load)	132V AC: 0.38 mA maximum 264V AC: 0.75 mA maximum	0.75mA maximum			1mA maximum	
		5V DC	69%	-	-	-	-	-
	Typical Efficiency	12V DC	75%	78%	-	-	-	-
	Emoloney	24V DC	79%	80%	83%	82%	84%	
	Output Current Ratings	5V DC	2.0A	-	-	-	-	-
		12V DC	1.2A	2.5A	-	-	-	-
	natingo	24V DC	0.65A	1.3A	2.5A	3.75A	5A	10A
	Voltage Adjustment		±10% (V. ADJ control on front)					
	Output Holding Time			:	20ms minimum ((at rated input and output)		
	Starting Time		200ms maximum	-	-	-	650ms maximum	500ms maximum
Ħ	Rise Time		100ms maximum (at rated input and output) 200ms maximum					
Outpi	Line Regulation		0.4% maximum					
0	Load Regulation		1.5% maximum 0.8% max					
	Temperature Regulation		0.05% degree C maximum					
	Ripple Voltage		2% pe	1% peak to peak maximum (including noise)				
	Overcurrent Protection		105% or more, auto reset 105 to 130%, auto reset 103 to 110%, auto reset					
	Overvoltage Protect	ction			120% r	nin. SHUTDOWN		
	Operation Indicato	r			L	ED (green)		
	Voltage Low Indication		LED (amber)	-	-	-	LED	(amber)

Specifications Con't								
-	PS5R-SB	PS5R-SC	PS5R-SD	PS5R-SE	PS5R-SF	PS5R-SG		
Parallel Operation			Ν	0				
Dielectric Strength	Between Input and Ground: 2000 VAC, 1 minute*							
Insulation Resistance		Between Input & Output Terminals: 100 MΩ Min						
Operating Temperature	–10 to +65°C (14 to 149°F)			-10 to 60°C (14 to 140°l	=)			
Storage Temperature			-25 to 75°C (-	13 to +167°F)				
Operating Humidity		20) to 90% relative hum	idity (no condensation)				
Vibration Resistance		I	Frequency 10 to 55Hz,	, Amplitude 0.375mm				
Shock Resistance			300m/s² (30G) 3 tin	nes each in 6 axes				
Approvale	EMC: EN61204-3 (EMI: Class B, EMS: Industrial), c-UL (CSA 22.2 No. 14), UL 1604, UL 508, LVD: EN60950, EN50178							
Αμμιοναίδ	UL1310 Class 2,	c-UL (CSA 22.2 No. 213	and 223)	-	SEMI	F47		
Harmonic Directive		N/A		E	N61000-3-2 A14 class A			
Weight (approx.)	160g	250g	285g	440g	630g	1000g		
Terminal Screw	M3.5 slotted-Phillips head screw (screw terminal type)							
IP protection	IP20 fingersafe							
Dimensions H x W x D (mm)	90 x 22.5 x 95	95 x 36 x 108		115 x 46 x 121	115 x 50 x 129	125 x 80 x 149.5		
Dimensions H x W x D (inches)	3.54 x 0.89 x 3.74	3.74 x 1.42 x 4.25		4.53 x 1.81 x 4.76	4.53 x 1.97 x 5.08	4.92 x 3.15 x 5.89		

Between input and output: 3000VAC, 1 minute; Between output and ground: 500VAC, 1 minute

Dimensions

PS5R-SB







PS5R-SE





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